Transmitted herewith for filing is the Patent Application of:

Inventor: MY THE DOAN

For:

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**VLSI-PHOTONIC HETEROGENEOUS INTEGRATION BY WAFER BONDING** 

19270 U.S. PTO 10/822201

Enclosed are:						
x <u>14</u>	14 sheets of drawing(s) - formal.					
An	An assignment of the invention to					
An	An associate power of attorney Applicant claims small entity status					
Red	Request & Certification under 35 USC 122(b)(2)(b)(i)					
The filing fee has been calculated as shown below:						
		(Col. 1)	(Col. 2)	OTHER THAN A SMALL ENTITY		
FOR:		NO. FILED	NO. EXTRA	RATE	FEE	
BASIC FEE	Ε	><	>		\$ 770.	
TOTAL CLAIMS		53 -20=	33	x 18 =	\$ 594.	
INDEP CLAIMS		4 -3=	11	x 86 =	\$ 86.	
			_	SUB TOTAL	\$ 1,450.	
			<u> </u>	ASSIGNMENT	\$0.	
_				TOTAL	\$ 1.450.	
X Ple	Please charge my Deposit Account No. 19-0033 in the amount of \$ 1,450. A duplicate copy of this sheet is enclosed.					
v	The Commissioner is hereby authorized to charge payment of the following fees associated with this communication or credit any					
overpayment to Deposit Account No. 19-0033. A duplicate copy of this sheet is enclosed.  X Any additional filing fees required under 37 CFR §1.16.						
Respectfully submitted						
	STEPHEN B. ACKERMAN, REG. NO. 37,761					

## **EXPRESS MAIL CERTIFICATE**

Express Mail No.EV385358806US

I hereby certify that this correspondence is being deposited with the United States Postal Service as Express Mail in an envelope addressed to Commissioner for Patents, P.O. Box 1450, Alexandria, VA, 22313-1450. Applicant and/or Attorney requests the date of deposit as the Filing Date.

Signature / Date